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. DEPARTMENT OF COMMERCE

Docket No: 24466US/4089P

U.S. Patent and Trademark Office

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

W-10-10-	
1. Name of conveying parties:	2. Name and address of receiving party:
(1) Shih-Ping HSU (2) Chao Wen SHIH	Name: PHOENIX PRECISION TECHNOLOGY CORPORATION
Additional name(s) of conveying party(ies) attached? ☐ Yes ■ No.	Street Address: No. 6, Li-Hsin Road, Science-Based Industrial Park, Hsin-Chu
	City: Hsin-chu State: Taiwan, R.O.C.
3. Nature of conveyance: Assignment Execution	Additional name(s) and address(es) attached? ☐ Yes No.
	(2) November 14, 2006 89
4. Application number(s) or patent number(s):	7-
If this document is being filed together with a new application, the execution date of the application is: November 14, 2006	
A. Patent Application No.(s)	B. Patent No.(s)
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5. Name and address of party to whom	C. Treatment of multi-ation and a start involved. One
correspondence concerning document should be mailed:	6. Total number of applications and patents involved: One
	7. Total fee (37 CFR 3.41)
Name: Sawyer Law Group LLP	■ Enclosed
Address: P.O. Box 51418	☐ Authorized to be charged to deposit account
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24466US(PPT-06348US)

ASSIGNMENT OF U.S. PATENT APPLICATION

In consideration of the sum of One Dollar in hand paid, and other good and valuable consideration, the

receipt of which is hereby acknowledged, the undersigned Inventor(s) (1) HSU, SHIH-PING (2) SHIH, CHAO WEN Full Name(s) Hereby sell, assign and transfer to Assignee PHOENIX PRECISION TECHNOLOGY CORPORATION Name and Address No. 6, Li-Hsin Road, Science-Based Industrial Park, Hsin-chu, Taiwan (R.O.C.) (hereinafter called the Assignee) the entire right, title, and interest in and to any and all improvements which are disclosed in the Application for United States Letters Patent entitled REPAIRED STRUCTURE OF CIRCUIT BOARD HAVING Title of Invention: PRE-SOLDERING BUMP AND METHOD FOR REPAIRING THE SAME Which application was a) executed by the undersigned on Complete either b) filed on the Serial No. Including any and all United States Letters Patents which may be granted therefore and any and all extensions, divisions, reissues, substitutes, renewals or continuations thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property. It is hereby authorized and requested that the Commissioner of Patents issue any and all of said Letters Patent, when granted, to said assignee. 00 Further, it is agreed that, when requested, without charge to but at the expense of sald Assignee, the undersigned will execute all divisional, continuing, substitute, renewal, and reissue patent applications; execute all rightful other papers; and generally do everything possible which said Assignee shall consider desirable for aiding in securing and maintaining proper patent protection. Taiwan (R.O.C.) Date Signed at 2006 November 14, Inventor(s) SHIH, CHAO WEN Full Signature(s)

2

PATENT REEL: 018633 FRAME: 0596